502319367 04/22/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shawn Powell	04/09/2013

RECEIVING PARTY DATA

Name:	FormFactor, Inc.	
Street Address:	7005 SoutFront Road	
City:	Livermore	
State/Country:	CALIFORNIA	
Postal Code:	94551	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13856091

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 801-426-2106

Email: dabalos@kmclaw.com
Correspondent Name: N. Kenneth Burraston
Address Line 1: 60 East South Temple

Address Line 2: Suite 1800

Address Line 4: Salt Lake City, UTAH 84111

NAME OF SUBMITTER:	N. Kenneth Burraston
Signature:	/N. Kenneth Burraston/
Date:	04/22/2013

Total Attachments: 1

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PATENT

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to FormFactor, Inc., a Delaware corporation, having a place of business at 7005 SouthFront Road, Livermore, CA 94551 ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the application for United States Letters Patent entitled: Wiring Substrate With Filled Vias To Accommodate Custom Terminals ("APPLICATION"), which:

is to be filed herewith (attorney docket no. <u>P362-US</u>) was filed on <u>April 3, 2013</u>, now bearing U.S. Serial No.: <u>13/856,091</u>; and

2. The entire worldwide right, title, and interest in and to:

(a) the APPLICATION, including any right of priority; (b) any non-provisional, divisional, continuation, substitute, renewal, reissue, and other related applications which have been or may be filed in the United States or elsewhere in the world; and (c) any patents which may be granted on the applications set forth in (a) and (b) above.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the right, title, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has made or will make hereafter no assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

Name & Signature

Date of Signature

Shawn Powell

4/9/2013